

## TOSHIBA LED Lamps

### TLSU1008A(T04),TLOU1008A(T04),TLAU1008A(T04) TLYU1008A(T04),TLGU1008A(T04),TLPGU1008A(T04)

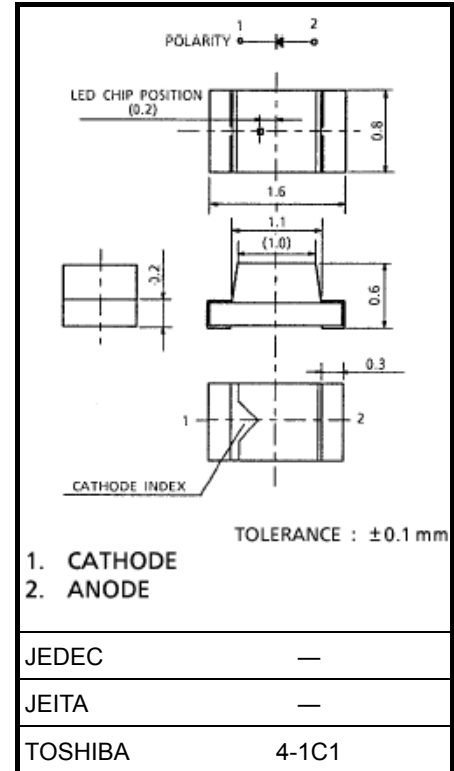
#### Panel Circuit Indicators

Unit: mm

- Surface-mount devices
- 1.6 (L) mm × 0.8 (W) mm × 0.6 (H) mm
- InGaAlP LEDs
- Replacing standard-intensity LEDs with high-intensity ones helps increase the brightness or reduce the power consumption of end products.
- Colors: red, orange, amber, yellow, green, pure green
- Applications:
  - Backlighting for battery-powered equipment
  - Pilot lamps for mobile handsets
  - Low-power electronic equipment, etc.
- Standard embossed tape packing: T04 (4000/reel)  
 4-mm tape reel

#### Color and Material

Part Number	Color	Material
TLSU1008A	Red	InGaAlP
TLOU1008A	Orange	
TLAU1008A	Amber	
TLYU1008A	Yellow	
TLGU1008A	Green	
TLPGU1008A	Pure Green	



Weight: 0.0013 g (typ.)

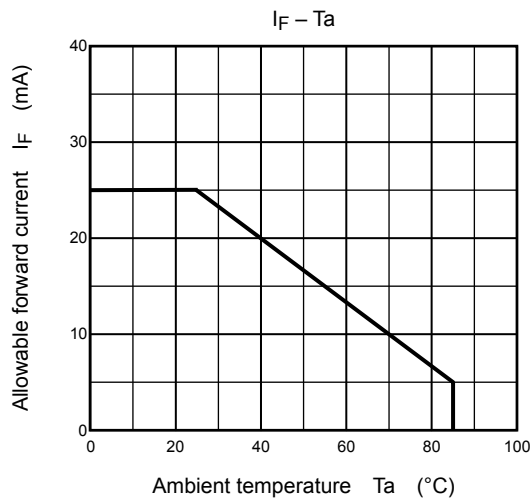
## Absolute Maximum Ratings (Ta = 25°C)

Part Number	Forward Current I <sub>F</sub> (mA) Please see Note 1	Reverse Voltage V <sub>R</sub> (V)	Power Dissipation P <sub>D</sub> (mW)	Operation Temperature T <sub>opr</sub> (°C)	Storage Temperature T <sub>stg</sub> (°C)
TLSU1008A	25	4	60	-40 to 85	-40 to 100
TLOU1008A			62.5		
TLAU1008A					
TLYU1008A					
TLGU1008A					
TLPGU1008A					

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Forward current derating



## Electrical Characteristics (Ta = 25°C)

Part Number	Forward Voltage V <sub>F</sub>			Reverse Current I <sub>R</sub>		
	Min	Typ.	Min	I <sub>F</sub>	Max	V <sub>R</sub>
TLSU1008A	—	2.0	2.5	20	50	4
TLOU1008A	—	2.1	2.5			
TLAU1008A	—	2.1	2.5			
TLYU1008A	—	2.1	2.5			
TLGU1008A	—	2.1	2.5			
TLPGU1008A	—	2.1	2.5			
Unit	V			mA	μA	V

## Optical Characteristics–1 (Ta = 25°C)

Part Number	Luminous Intensity I <sub>v</sub>				Available I <sub>v</sub> rank Please see Note 2
	Min	Typ.	Max	I <sub>F</sub>	
TLSU1008A	27.2	60	—	20	L / M / N / P
TLOU1008A	27.2	78	—	20	L / M / N / P
TLAU1008A	8.5	30	—	20	J / K / L / M
TLYU1008A	8.5	30	—	20	J / K / L / M
TLGU1008A	8.5	30	—	20	J / K / L / M
TLPGU1008A	1.53	6	—	20	F / G / H / J
Unit	mcd	mcd	mcd	mA	—

Note 2: The specification on the above table is used for I<sub>v</sub> classification of LEDs in Toshiba facility.  
Each reel includes the same rank LEDs. Let the delivery ratio of each rank be unquestioned.

Rank	Luminous Intensity I <sub>v</sub>	
	Min	Min
F	1.53	4.14
G	2.72	7.36
H	4.76	12.9
J	8.5	23
K	15.3	41.4
L	27.2	73.6
M	47.6	129
N	85	230
P	153	414
Unit	mcd	mcd

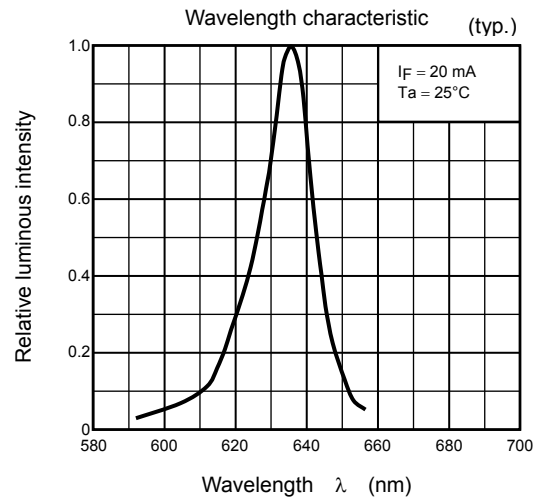
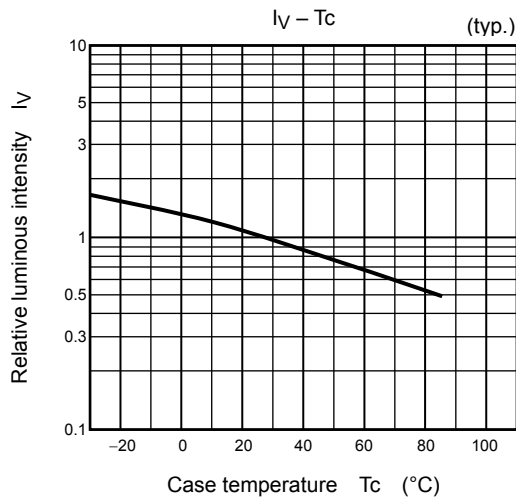
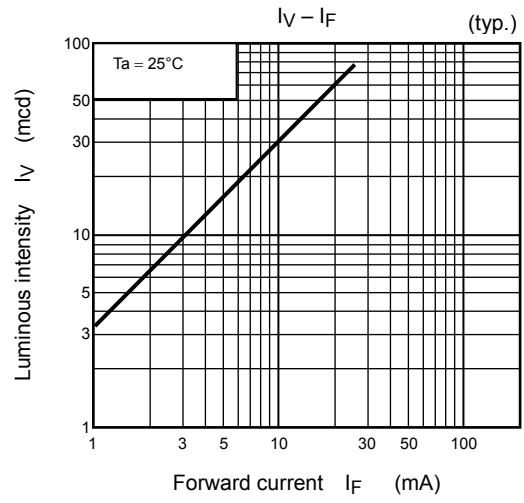
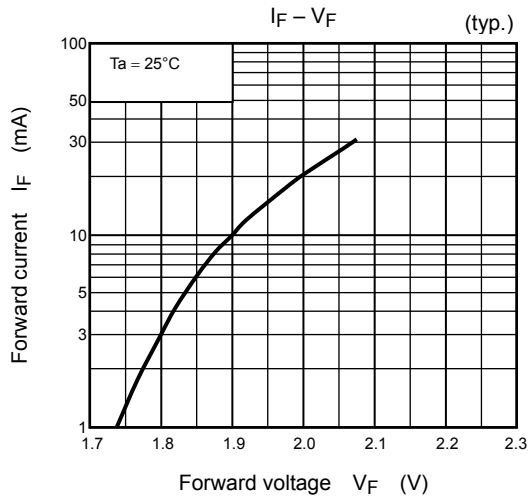
## Optical Characteristics–2 (Ta = 25°C)

Part Number	Emission Spectrum							
	Peak Emission Wavelength λ <sub>p</sub>			Δλ Typ.	Dominant Wavelength λ <sub>d</sub>			I <sub>F</sub>
	Min	Typ.	Max		Min	Typ.	Max	
TLSU1008A	—	636	—	17	617	623	631	
TLOU1008A	—	612	—	15	599	605	613	
TLAU1008A	—	596	—	13	585	592	599	
TLYU1008A	—	590	—	13	580	587	595	
TLGU1008A	—	574	—	11	565	571	576	
TLPGU1008A	—	562	—	11	—	557	564	
Unit	nm			nm	nm			mA

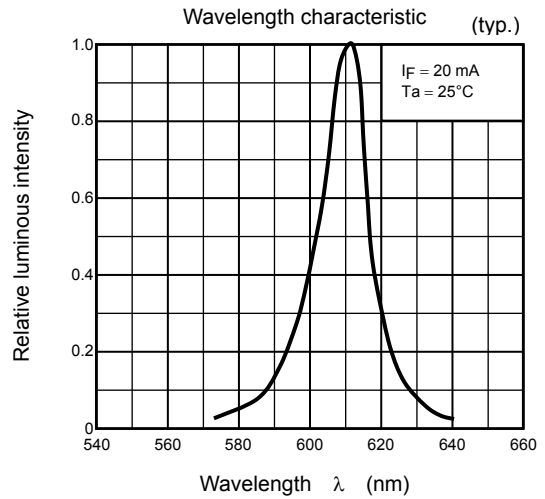
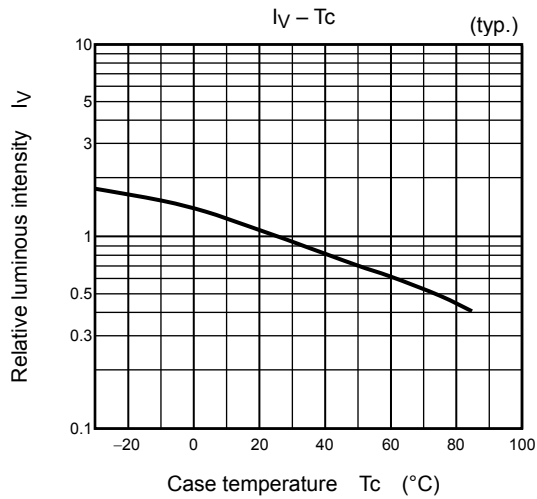
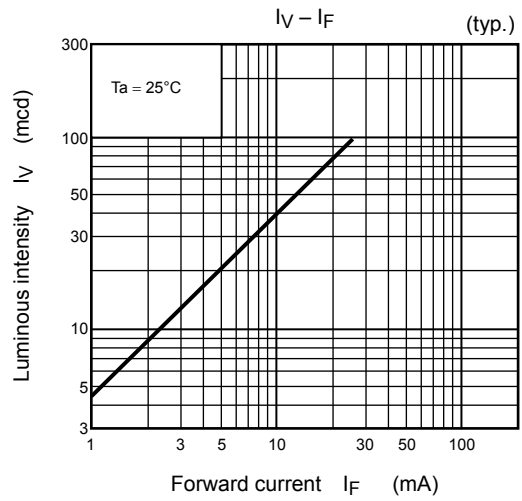
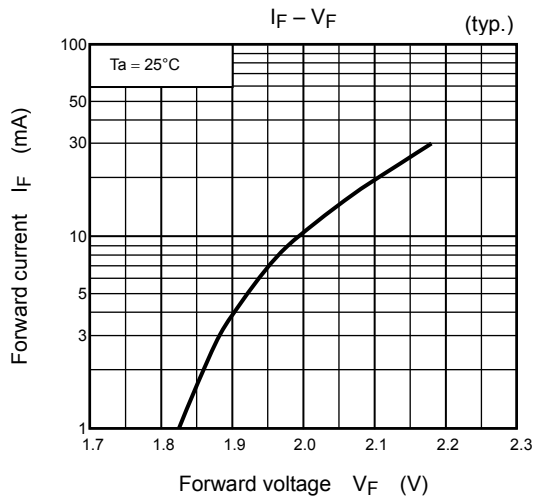
## Cautions

- This visible LED lamp also emits some IR light.  
If a photodetector is located near the LED lamp, please ensure that it will not be affected by the IR light.
- This product is designed as a general display light source usage, and it has applied the measurement standard that matched with the sensitivity of human's eyes. Therefore, it is not intended for usage of functional application (ex. Light source for sensor, optical communication and etc) except general display light source.

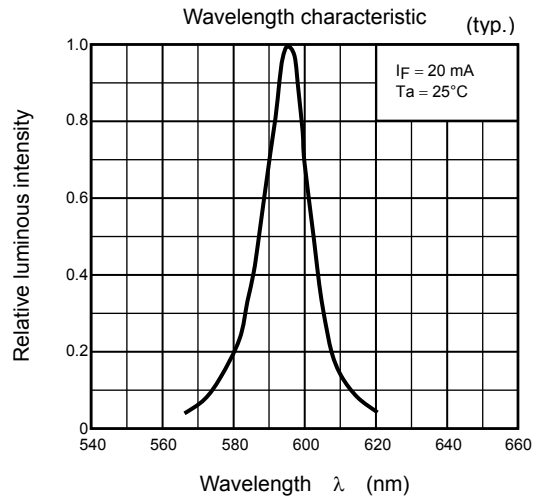
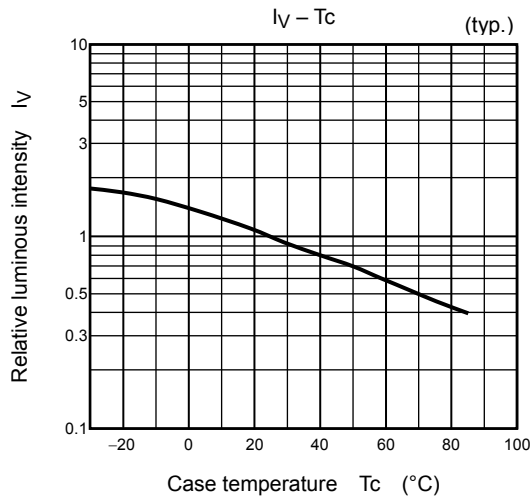
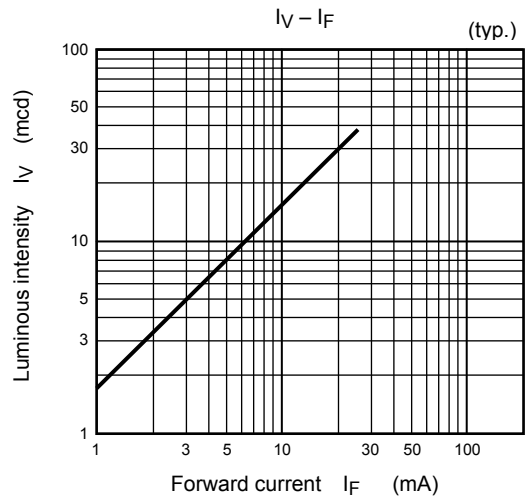
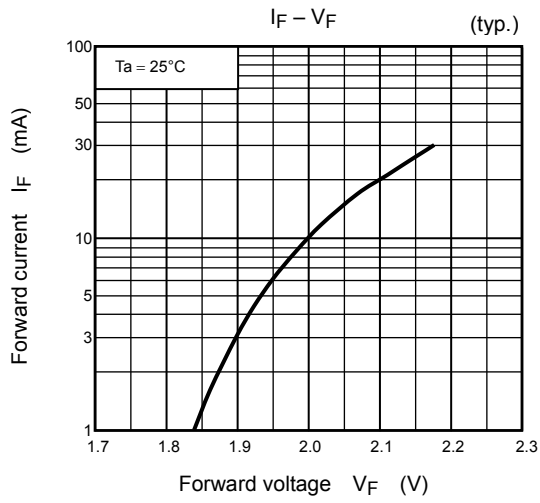
## TLSU1008A



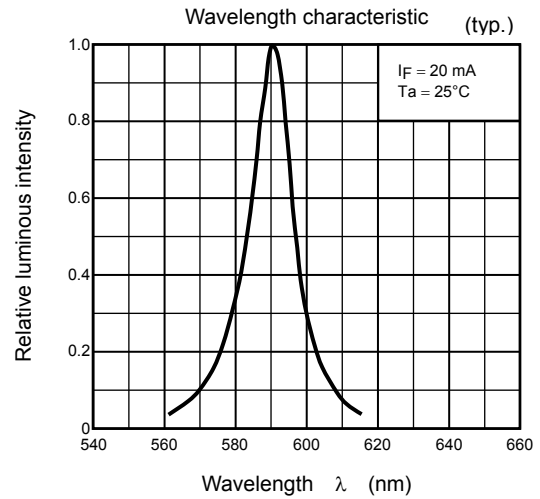
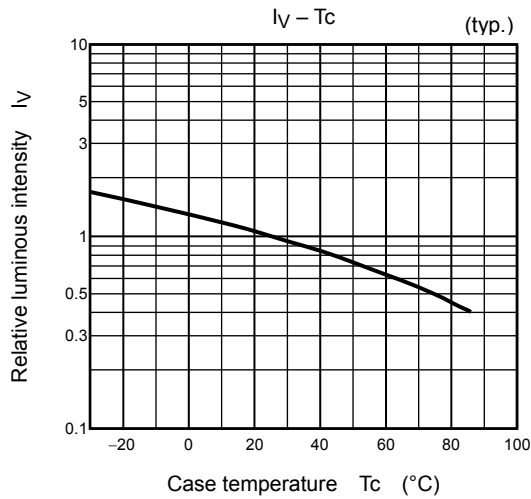
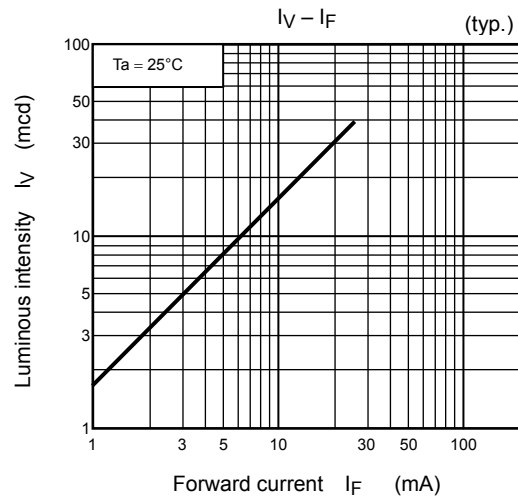
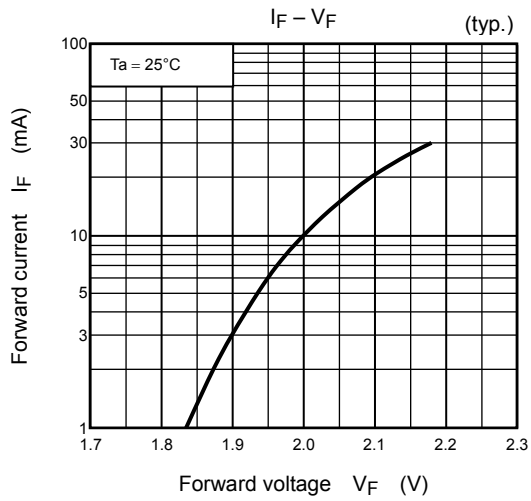
**TLOU1008A**



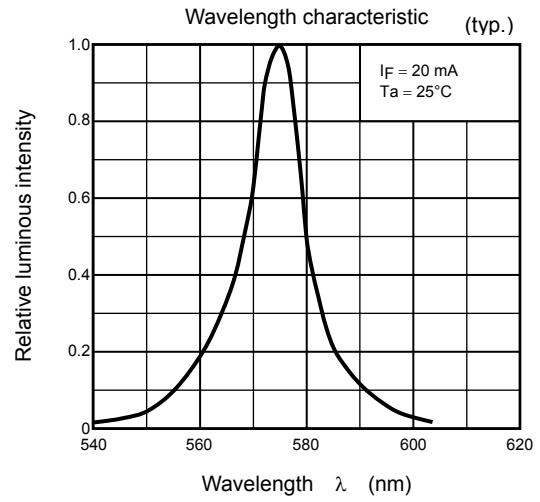
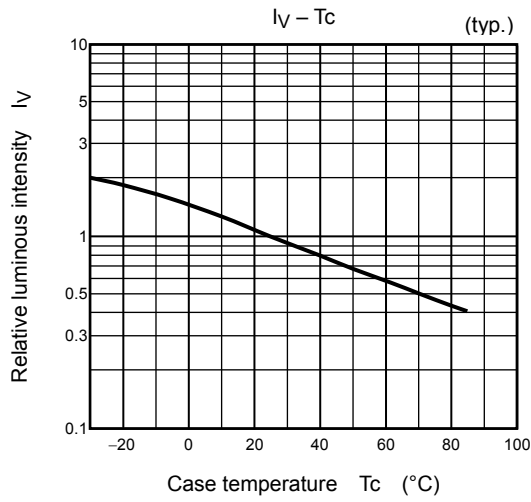
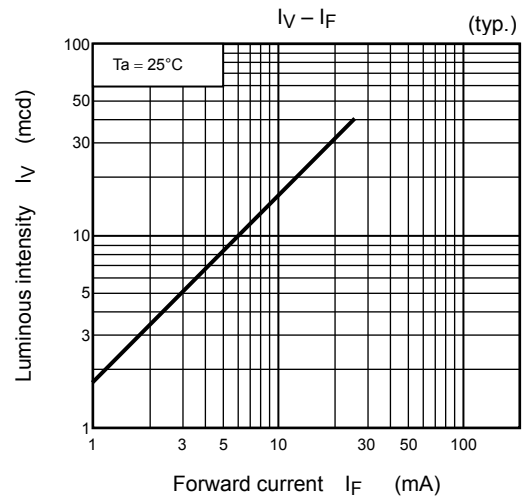
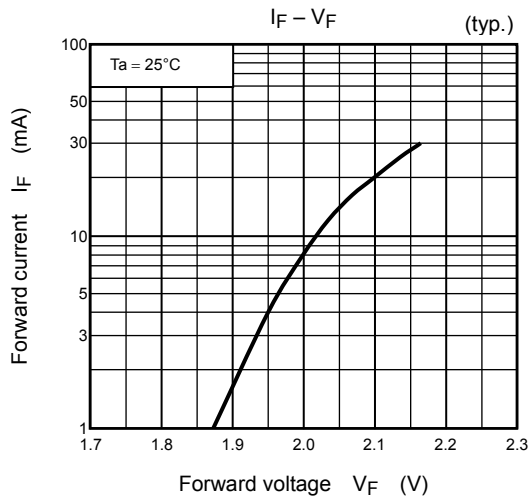
**TLAU1008A**



## TLYU1008A

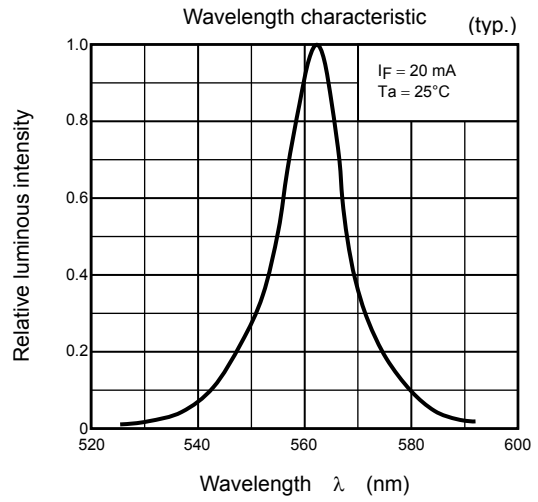
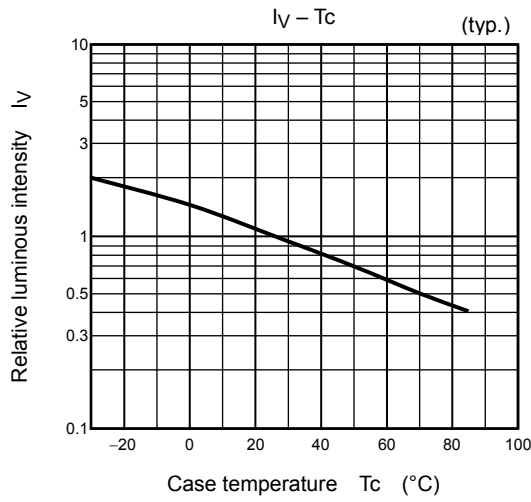
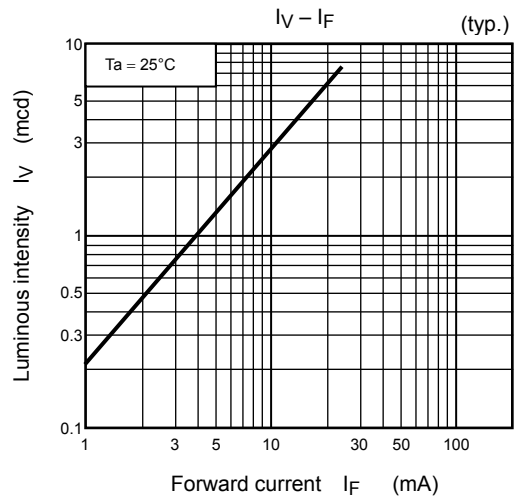
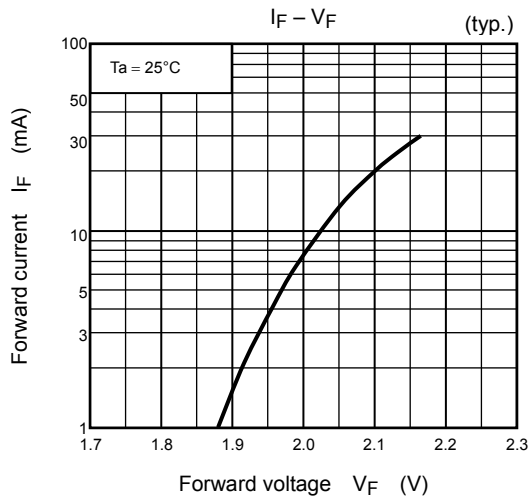


### TLGU1008A



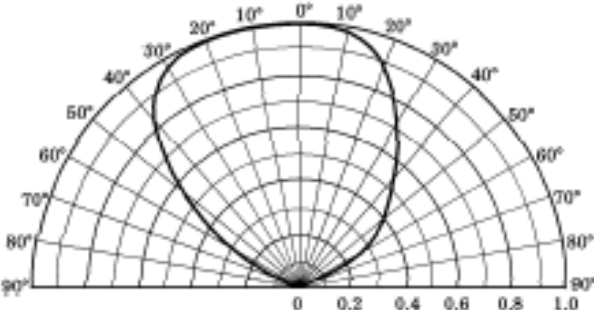


**TLPGU1008A**

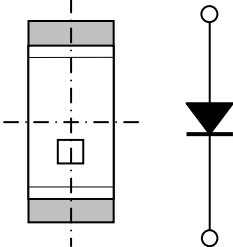
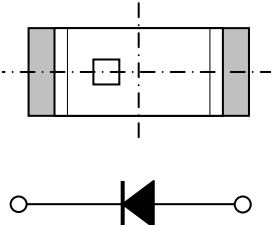
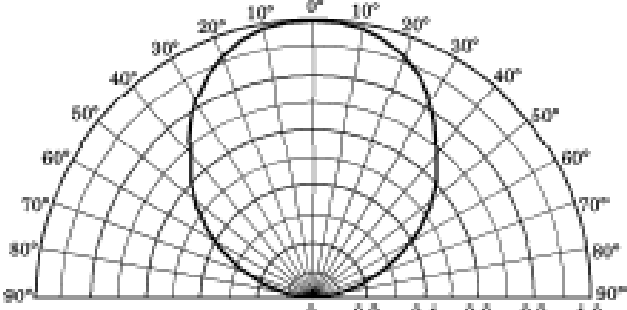


**Radiation Pattern**

Vertical to polarity



Horizontal to polarity Ta=25°C



## Packaging

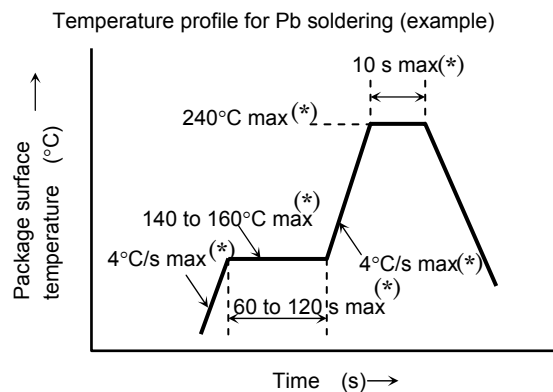
These LED devices are packed in an aluminum envelope with a silica gel and a moisture indicator to avoid moisture absorption. The optical characteristics of the devices may be affected by exposure to moisture in the air before soldering and they should therefore be stored under the following conditions:

1. This moisture proof bag may be stored unopened within 12 months at the following conditions.  
 Temperature: 5°C to 30°C  
 Humidity: 90% (max)
2. After opening the moisture proof bag, the devices should be assembled within 168 hours in an environment of 5°C to 30°C/70% RH or below.  
 When performing lead(Pb)-free soldering, the devices should be assembled within 72 hours in an environment of 5°C to 30°C/70% RH or below.
3. If upon opening, the moisture indicator card shows humidity 30% or above (Color of indication changes to pink) or the expiration date has passed, the devices should be baked in taping with reel.  
 After baking, use the baked devices within 72 hours, but perform baking only once.  
 Baking conditions: 60±5°C, for 12 to 24 hours.  
 Expiration date: 12 months from sealing date, which is imprinted on the same side as this label affixed.
4. Repeated baking can cause the peeling strength of the taping to change, then leads to trouble in mounting.  
 Furthermore, prevent the devices from being destructed against static electricity for baking of it.
5. If the packing material of laminate would be broken, the air tightness would deteriorate. Therefore, do not throw or drop the packed devices.

## Mounting Method

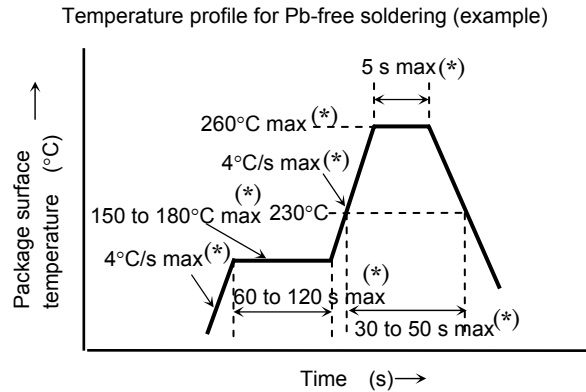
### Soldering

- Reflow soldering (example)



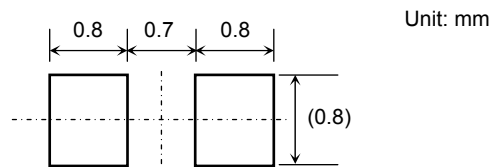
- The products are evaluated using above reflow soldering conditions. No additional test is performed exceed the condition (i.e. the condition more than (\*)MAX values) as a evaluation. Please perform reflow soldering under the above conditions.
- Please perform the first reflow soldering with reference to the above temperature profile and within 168 h of opening the package.
- Second reflow soldering  
 In case of second reflow soldering should be performed within 168 h of the first reflow under the above conditions.  
 Storage conditions before the second reflow soldering: 30°C, 70% RH (max)
- Make any necessary soldering corrections manually.  
 (only once at each soldering point)  
 Soldering iron: 25 W  
 Temperature: 300°C or less  
 Time: within 3 s
- Do not perform wave soldering.

- Reflow soldering (example)



- The products are evaluated using above reflow soldering conditions. No additional test is performed exceed the condition (i.e. the condition more than (\*)MAX values) as a evaluation. Please perform reflow soldering under the above conditions.
- Please perform the first reflow soldering with reference to the above temperature profile and within 72 h of opening the package.
- Second reflow soldering  
In case of second reflow soldering should be performed within 72 h of the first reflow under the above conditions. Storage conditions before the second reflow soldering: 30°C, 70% RH (max)
- Make any necessary soldering corrections manually.  
(only once at each soldering point)  
Soldering iron: 25 W  
Temperature: 300°C or less  
Time: within 3 s
- Do not perform wave soldering.

### Recommended Soldering Pattern



### Cleaning

When cleaning is required after soldering, Toshiba recommends the following cleaning solvents. It is confirmed that these solvents have no effect on semiconductor devices in our dipping test (under the recommended conditions). In selecting the one for your actual usage, please perform sufficient review on washing condition, using condition and etc.

ASAHI CLEAN AK-225AES:	(made by ASAHI GLASS)
KAO CLEAN THROUGH 750H:	(made by KAO)
PINE ALPHA ST-100S:	(made by ARAKAWA CHEMICAL)

### Precaution When Mounting

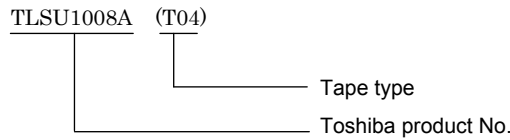
Do not apply force to the plastic part of the LED under high-temperature conditions. To avoid damaging the LED plastic, do not apply friction using a hard material. When installing the PCB in a product, ensure that the device does not come into contact with other components.

## Tape Specifications

### 1. Product Number Format

The type of package used for shipment is denoted by a symbol suffix after the product number. The method of classification is as below. (However, this method does not apply to products whose electrical/optical characteristics differ from standard Toshiba specifications)

- (1) Tape Type: T04 (4-mm pitch)
- (2) Example



### 2. Handling Precautions

Tape material protected against static electricity. However, static electricity may occur depending on quantity of charged static electricity and a device may attach to a tape, or a device may be unstable when peeling a tape cover.

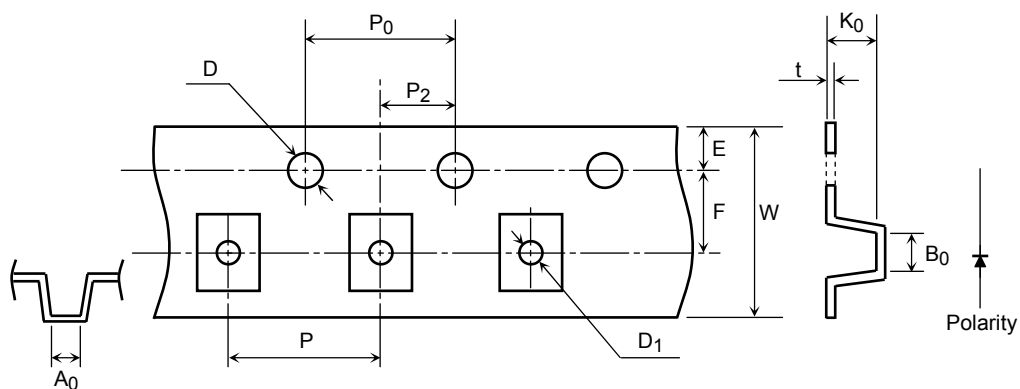
- (a) Since tape materials may accumulate an electrostatic charge, use an ionizer to neutralize the ambient air.
- (b) For transport and temporary storage of devices, use containers (boxes and bags) and jigs that are made of anti-static materials or of materials which dissipate electrostatic charge.

### 3. Tape Dimensions

Unit: mm

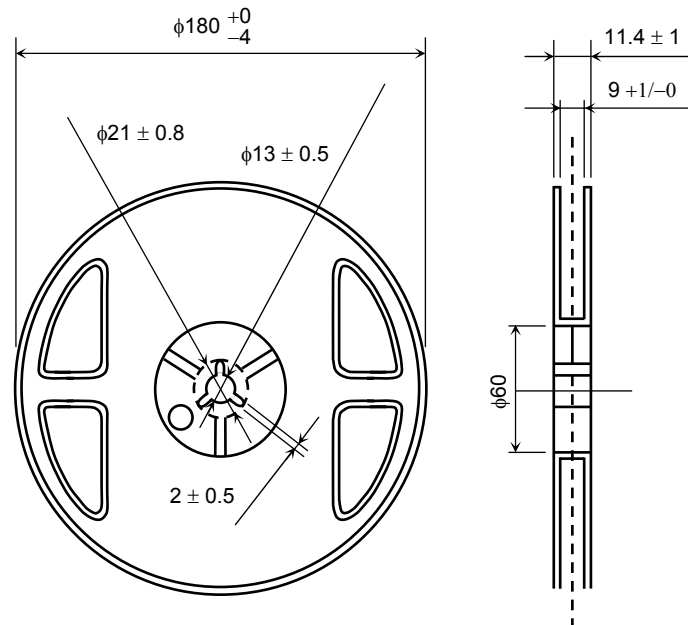
Symbol	Value	Tolerance
D	1.50	+0.1/-0
E	1.75	±0.1
P <sub>0</sub>	4.00	±0.1
T	0.20	±0.05
F	3.50	±0.05
D <sub>1</sub>	0.60	±0.05

Symbol	Value	Tolerance
P <sub>2</sub>	2.00	±0.05
W	8.00	±0.1
P	4.00	±0.1
A <sub>0</sub>	0.90	±0.1
B <sub>0</sub>	1.75	±0.1
K <sub>0</sub>	0.75	±0.1

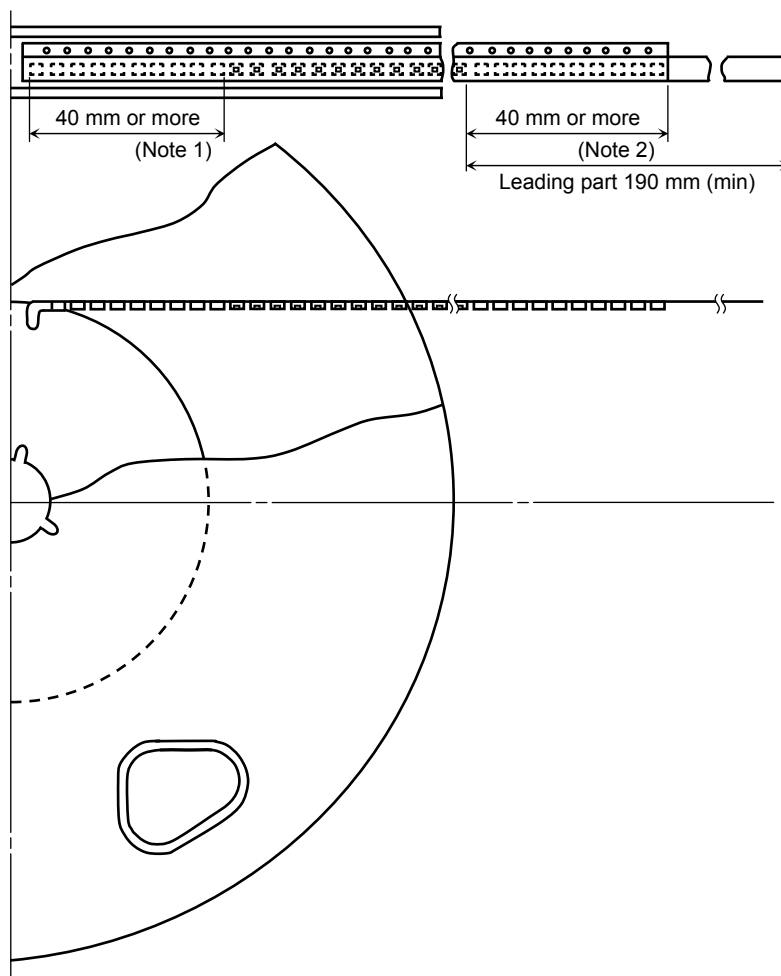


**4. Reel Dimensions**

Unit: mm



**5. Leader and Trailer Section of Tape**



Note 1: Empty trailer section

Note 2: Empty leader section



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- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
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